104130-4 - ACTIVE

#### AMP-LATCH

TE Internal #: 104130-4 Ribbon Cable Connectors, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Right Angle, Through Hole - Solder, 2 Row, Receptacle, Low Profile

#### View on TE.com >

Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Board-to-Board

Number of Positions: 20

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Retention: Without

PCB Mount Orientation: Right Angle

# Features

**E T E connectivity** 

#### **Product Type Features**

Ribbon Cable Connector Header Type	Pin Header
Connector Product Type	Connector Assembly
Connector System	Board-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	20
PCB Mount Orientation	Right Angle
Number of Rows	2
Electrical Characteristics	
Insulation Resistance	5000 ΜΩ
Body Features	
Daisy Chain	With
Primary Product Color	Black

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Contact FeaturesMating Square Post Dimension.64 mm[.025 in]PCB Contact Termination Area Plating Material Thickness2.54 µm[100 µin]Contact TypePin30 µin30 µinContact Mating Area Plating MaterialGold, Gold Flash, Gold Flash over Palladium NickelContact Shape & FormSquareContact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialTin-LeadContact Base MaterialCopper AlloyContact Termination Area Plating MaterialCopper AlloyContact Current Rating (Max)1 Aemination Features.64 mm[.025 in]Square Termination Post & Tail Dimension.64 mm[.135 in]Termination Method to Printed Circuit BoardThrough Hole - Solder	Connector Profile	Low
PCB Contact Termination Area Plating Material Thickness2.54 μm[100 μin]Contact TypePin30 μin30 μinContact Mating Area Plating MaterialGold, Gold Flash, Gold Flash over Palladium NickelContact Shape & FormSquareContact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialTin-LeadContact Current Rating (Max)1 AContact Current Rating (Max).64 mm[.025 in]Square Termination Post & Tail Dimension.64 mm[.035 in]	Contact Features	
Contact TypePin30 µinContact Mating Area Plating MaterialGold, Gold Flash, Gold Flash over Palladium NickelContact Shape & FormSquareContact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialTin-LeadContact Base MaterialCopper AlloyContact Current Rating (Max)1 ASquare Termination Post & Tail Dimension.64 mm[.025 in]Termination Post & Tail Length3.43 mm[.135 in]	Mating Square Post Dimension	.64 mm[.025 in]
And30 µinContact Mating Area Plating MaterialGold, Gold Flash, Gold Flash over Palladium NickelContact Shape & FormSquareContact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialTin-LeadContact Base MaterialCopper AlloyContact Quirent Rating (Max)1 ASquare Termination Post & Tail Dimension.64 mm[.025 in]Termination Post & Tail Length3.43 mm[.135 in]	PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
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Contact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialTin-LeadContact Base MaterialCopper AlloyContact Current Rating (Max)1 AContact Current Rating (Max)Square Termination Post & Tail DimensionTermination Post & Tail Length3.43 mm[.135 in]	Contact Mating Area Plating Material	
PCB Contact Termination Area Plating Material Tin-Lead Copper Alloy Contact Base Material Copper Alloy Contact Current Rating (Max) 1 A ermination Features Square Termination Post & Tail Dimension .64 mm[.025 in] Termination Post & Tail Length 3.43 mm[.135 in]	Contact Shape & Form	Square
Contact Base MaterialCopper AlloyContact Current Rating (Max)1 Acermination Features·································	Contact Underplating Material	Nickel
Contact Current Rating (Max)1 ACermination Features.64 mm[.025 in]Square Termination Post & Tail Dimension.64 mm[.135 in]Termination Post & Tail Length3.43 mm[.135 in]	PCB Contact Termination Area Plating Material	Tin-Lead
iermination Features         Square Termination Post & Tail Dimension       .64 mm[.025 in]         Termination Post & Tail Length       3.43 mm[.135 in]	Contact Base Material	Copper Alloy
Square Termination Post & Tail Dimension.64 mm[.025 in]Termination Post & Tail Length3.43 mm[.135 in]	Contact Current Rating (Max)	1 A
Termination Post & Tail Length 3.43 mm[.135 in]	ermination Features	
	Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to Printed Circuit Board Through Hole - Solder	Termination Post & Tail Length	3.43 mm[.135 in]
	Termination Method to Printed Circuit Board	Through Hole - Solder

## Mechanical Attachment

Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	Without
Mating Alignment Type	Center, Dual Polarizing Bar
Mating Retention	With
Mating Retention Type	Ejection Latch
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Shrouded End Dimension	3.81 mm[.15 in]
Connector Length	22.86 mm[1.3 in]

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Connector Height	9.77 mm[.38 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	72
Packaging Method	Tray

# Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU

Not Compliant

EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (13% in COMPONENT PART) Aticle Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Not lead free process capable

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous

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materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



# Customers Also Bought







# Documents

Product Drawings 020 LOPRO HDR RA 30DP LATCH

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English **CAD** Files 3D PDF 3D **Customer View Model** ENG\_CVM\_CVM\_104130-4\_H.2d\_dxf.zip English **Customer View Model** ENG\_CVM\_CVM\_104130-4\_H.3d\_igs.zip English **Customer View Model** ENG\_CVM\_CVM\_104130-4\_H.3d\_stp.zip English By downloading the CAD file I accept and agree to the Terms and Conditions of use **Product Specifications Product Specification** English Agency Approvals Agency Approval Document

English